

FFP06U40DN

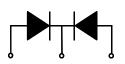
Features

- · Ultrafast with soft recovery
- · Low forward voltage

Applications

- Power switching circuits
- Output rectifiers
- Freewheeling diodes
- Switching mode power supply





1. Anode 2. Cathode 3. Anode

ULTRA FAST RECOVERY POWER RECTIFIER

Absolute Maximum Ratings (per diode) T_C=25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------------------------|---|--------------|-------|
| V _{RRM} | Peak Repetitive Reverse Voltage | 400 | V |
| I _{F(AV)} | Average Rectified Forward Current @ T _C = 100°C | 6 | Α |
| I _{FSM} | Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave | 60 | Α |
| T _{J,} T _{STG} | Operating Junction and Storage Temperature | - 65 to +150 | °C |

Thermal Characteristics

| Symbol | Parameter | Value | Units |
|-------------------|--|-------|-------|
| R _{e.IC} | Maximum Thermal Resistance, Junction to Case | 7.0 | °C/W |

Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

| Symbol | Parameter | | Min. | Тур. | Max. | Units |
|-------------------|---------------------------------------|---|------|------|------|-------|
| V _{FM} * | Maximum Instantaneous Forward Voltage | | | | | V |
| | $I_F = 6A$ | T _C = 25 °C | - | - | 1.4 | |
| | I _F = 6A | $T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$ | - | - | 1.3 | |
| I _{RM} * | Maximum Instantaneous Reverse Current | | | | | μΑ |
| | @ rated V _R | $T_C = 25 ^{\circ}C$ | - | - | 20 | |
| | | $T_C = 25$ °C $T_C = 100$ °C | - | - | 200 | |
| t _{rr} | Maximum Reverse Recovery Time | | - | - | 50 | ns |
| I _{rr} | Maximum Reverse Recovery Current | | - | - | 4.0 | Α |
| Q _{rr} | Maximum Reverse Recovery Charge | | - | - | 100 | nC |
| | $(I_F = 6A, di/dt = 200A/\mu s)$ | | | | | |
| W _{AVL} | Avalanche Energy | | 1.0 | - | - | mJ |

^{*} Pulse Test: Pulse Width=300µs, Duty Cycle=2%

Typical Characteristics

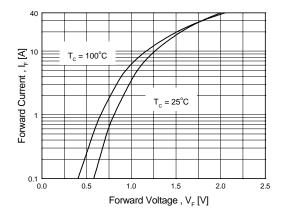


Figure 1. Typical Forward Voltage Drop vs. Forward Current

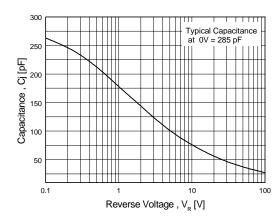


Figure 3. Typical Junction Capacitance

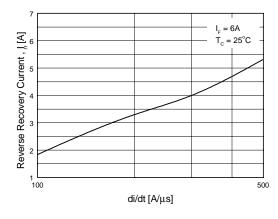


Figure 5. Typical Reverse Recovery Current vs. di/dt

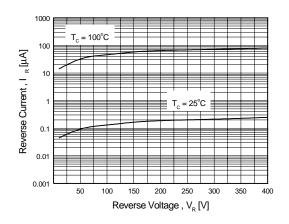


Figure 2. Typical Reverse Current vs. Reverse Voltage

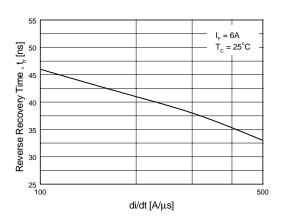


Figure 4. Typical Reverse Recovery Time vs. di/dt

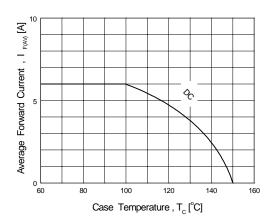
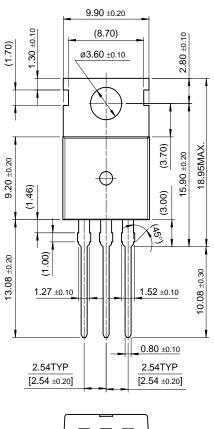
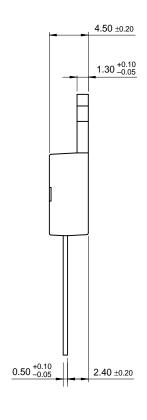


Figure 6. Forward Current Derating Curve

Package Dimensions

TO-220





10.00 ±0.20

Dimensions in Millimeters

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